TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (MACH II π -MOS VI)

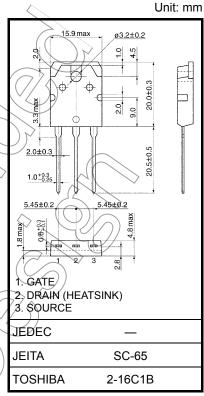
2SK3936

Switching Regulator Applications

- Small gate charge: Qg = 60 nC (typ.)
- Fast reverse recovery time: t_{rr} = 380 ns (typ.)
- Low drain-source ON-resistance: $R_{DS (ON)} = 0.2 \Omega (typ.)$
- High forward transfer admittance: $|Y_{fS}| = 16.5 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 500 \mu A (V_{DS} = 500 V)$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	(Unit)
Drain-source voltage			V_{DSS}	500	\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V_{DGR}	500	×
Gate-source voltage			V_{GSS}	±30	> v
Drain current	DC	(Note 1)	ΙD	23	Α
	Pulse	(Note 1)	I _{DP}	92	A .
Drain power dissipation (Tc = 25°C)			PD	150	/\w
Single-pulse avalanche energy (Note 2)			E _A \$	759	E.
Avalanche current			TAR	23	A
Repetitive avalanche energy (Note 3)			((E _{AR}))	15	/mJ
Channel temperature			Tch	150	₹Ĉ
Storage temperature range			T _{stg}	-55 to 150	°C



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

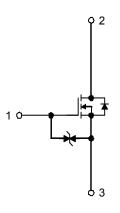
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	0.833	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 2.44 mH, $I_{AR} = 23 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



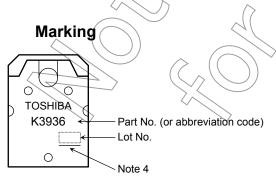
Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	I _{GSS} V _{GS} = ±25 V, V _{DS} = 0 V — ±10		μΑ		
-		V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_		V
Drain cutoff curre	Orain cutoff current IDSS		V _{DS} = 500 V, V _{GS} = 0 V	_	_	500	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	_		V
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) /~	4.0	V
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 11.5 A	>~	0.2	0.25	Ω
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 11.5 A	8	16.5		S
Input capacitance		C _{iss}		_	4250		
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	10		pF
Output capacitance		C _{oss}		_	420		
Switching time	Rise time	t _r	10 V ID = 11.5 A VOUT VGS	-	12		
	Turn-on time	t _{on}	4.7Ω \$ R _L = \ 17.4 Ω		45) —	
	Fall time	t _f	V _{DD} ≈ 200 V	7	> 10		ns
	Turn-off time	t _{off}	Duty ≤ 1%, t _W = 10 μs		80		
Total gate charge		Qg) —	60		
Gate-source charge		Qgs	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$	_	50	_	nC
Gate-drain charge Q		Qgd			10	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1))) I _{DR}		_	_	23	Α
Pulse drain reverse current (Note 1)	IDRP		_	_	92	Α
Forward voltage (diode)	V _{DSF}	1 _{DR} = 23 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rī}	I _{DR} = 23 A, V _{GS} = 0 V,	_	380	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	2.4	_	μС

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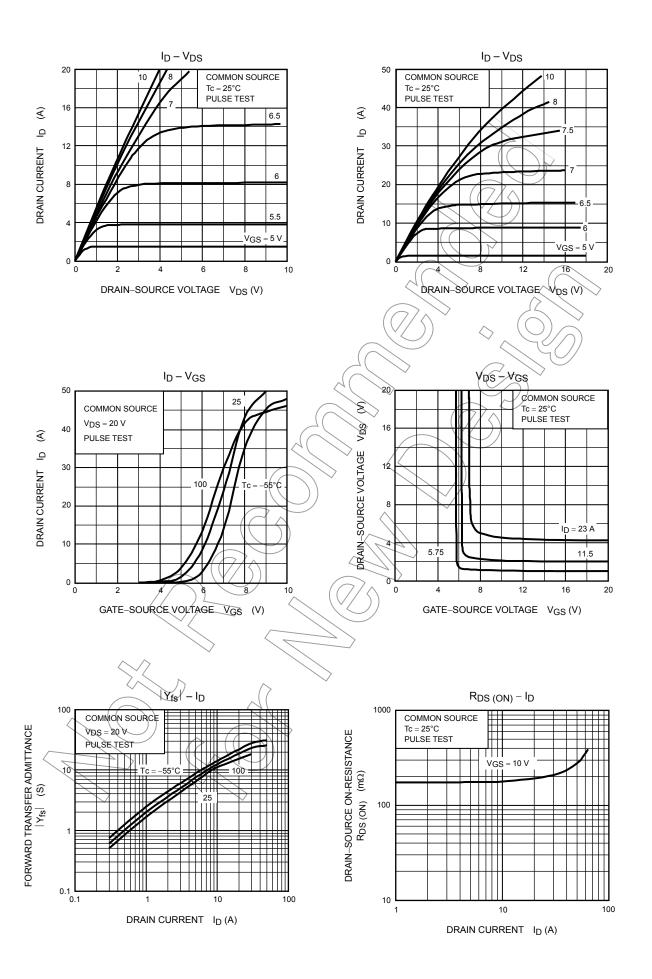


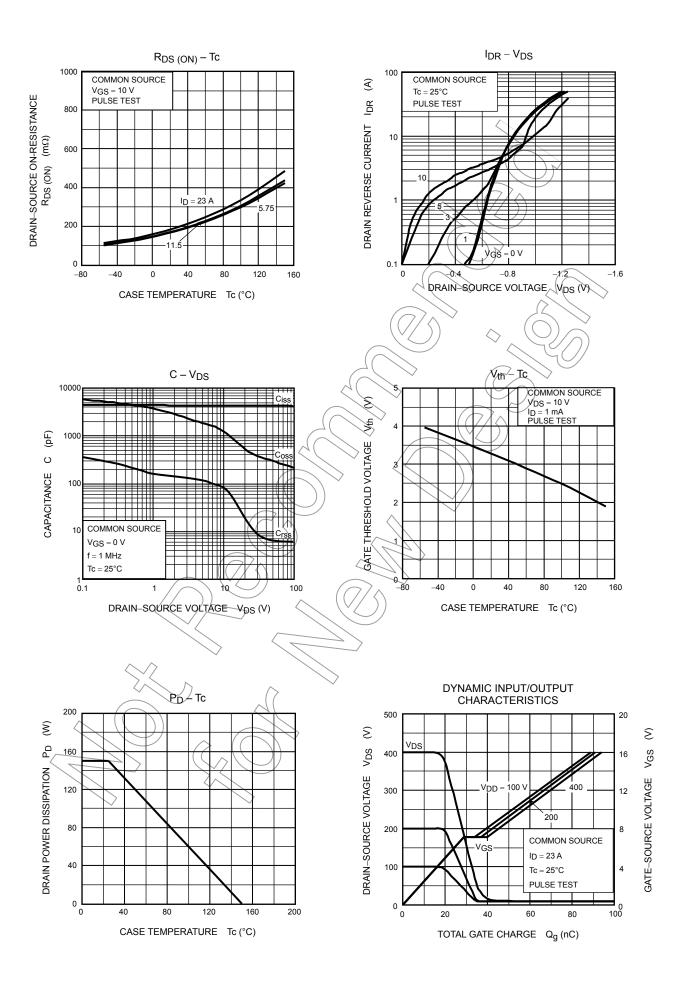
Note 4: A line under a Lot No. identifies the indication of product Labels.

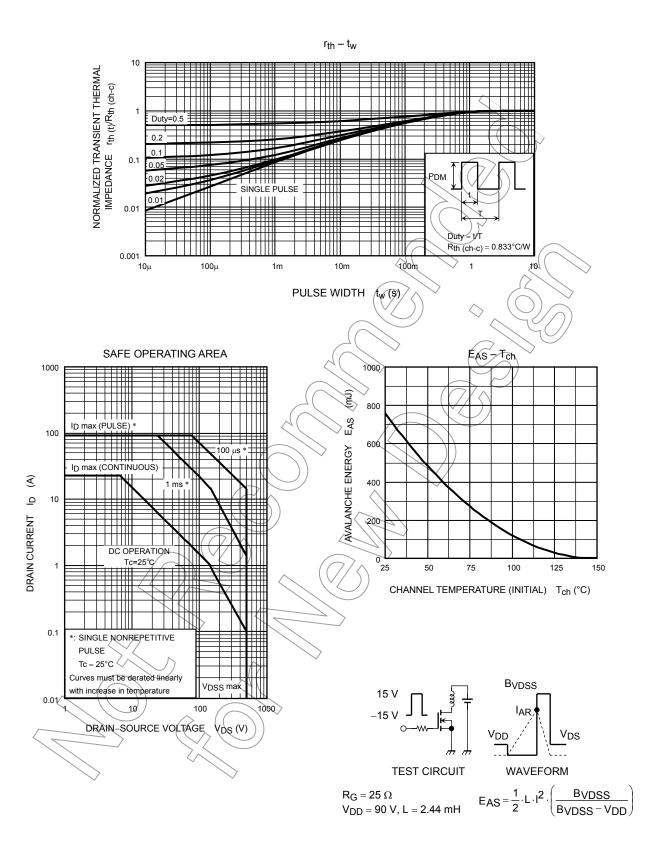
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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